Customer No.: 31561 Application No.: 10/605,360

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remarks.

Amendment

FOR THE SPECIFICATION

[0028] In a preferred embodiment of the present invention, the following steps

shown in FIG. 1B' and FIG. 1B" can be performed between FIG. 1B and FIG. 1C. First,

a lining oxide layer 107(not shown) is formed on the surface of the gate structure 105 and

the substrate 100, as shown in FIG. 1B'. Then the lining oxide layer 107 is etched back so

that only the sidewall of the gate structure 105 has the remaining lining oxide layer 107a

thereon, as shown in FIG. 1B". Then, the step shown in FIG. 1C is performed to form the

metal silicide layer 108. Therefore, the metal silicide layer 108 would not be formed on

the sidewall of the gate structure 105.

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